

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No.	:	10/530,438	Confirmation No. 5347
Applicant	:	Takco Okabe et al.	
371 Filed	:	April 6, 2005	
Art Unit	:	1793	
Examiner	:	Sikyin Ip	
Customer No.	:	00270	
Title	:	COPPER ALLOY SPUTTERING TARGET AND SEMICONDUCTOR ELEMENT WIRING	

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**RESPONSE TO RESTRICTION REQUIREMENT**

Sir:

This is a timely response to the written Restriction Requirement dated January 15, 2008.

Election

In the present application, Applicant elects without traverse to prosecute the invention directed to a copper alloy sputtering target comprising Al and Si as essential elements (Group I).

Thus, the Group I claims are elected and include claims 1-3, 15-20 and 26-28.